

RX-IF SIMMIC FOR W-CDMA AGC + I/Q DEMODULATOR

UPC8190K

FEATURES

- Rx-IF: 380 MHz
- LOW POWER CONSUMPTION: VCC = 3.0 V
- SMALL 20 PIN QFN PACKAGE
 Flat lead style for better performance
- TAPE AND REEL PACKAGING AVAILABLE

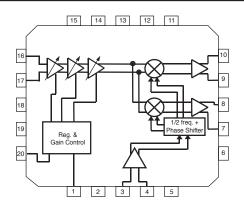
DESCRIPTION

NEC's UPC8190K is a Silicon Monolithic Integrated Circuit designed as a receiver (RX) section for W-CDMA. The UPC8190K is a RX-IF IC including IF-AGC amplifier and demodulator. This IC is suitable for kit-use for W-CDMA IF section.

This IC was developed using NEC's new ultra high speed silicon bipolar process.

NEC's stringent quality assurance and test procedures ensure the highest reliability and perormance.

BLOCK DIAGRAM



APPLICATIONS

· W-CDMA

ELECTRICAL CHARACTERISTICS (unless otherwise specified, TA = 25°C, Vcc = 3.0 V, fif = 382.5 MHz, flo =

760 MHz, $P_{LO} = -15 \text{ dBm}$, fI/Q = 2.5 MHz)

| | PART NUMBER PACKAGE OUTLINE | UP8190K QFN-20 | | | |
|-----------------|--|-------------------|----------|----------|---------|
| SYMBOLS | PARAMETERS AND CONDITIONS | UNITS mA μA | MIN | TYP | 12 1 |
| lcc | Circuit Current, no signals at power saving mode | | _ _ | 9 | |
| V _{G1} | Voltage Gain, Vcont= 2.5 V | dB | 68 | 77 | _ |
| V _{G2} | VCONT= 0.5 V | dB | _ | -20 | -15 |
| IIP3 | Third Order Input Intercept Point, Rs = 600Ω balanced, Gain= +65 dB PıN = -70 dB Gain= -10 dB PıN = -10 dB | dBm | -60 0 | -55 3 | _ _ |
| LoL | Local Leakage, Leakage to I/Q port when local = 760 MHz and output = 30mVp-p balanced | dBc | - | - | 20 |
| BW(I/Q) | I/Q Bandwidth, 3 dB down | MHz | 10 | _ | _ |
| Vout(sat) | I/Q Maximum output swing, Balanced ouptut | Vp-p | 1 | _ | _ |
| AE | I/Q Gain Balance, fI/Q = 2.5 MHz | dB | _ | _ | Δ0.5 |
| PE | I/Q Phase Error, fI/Q = 2.5 MHz | deg | _ | _ | ±4 |
| GACC | Gain Accuracy, VCONT = 1 to 2 V | dB/V | _ | Δ 4.6 | Δ6 |
| TPS(Rise) | Rise time from power-saving mode | us | _ | _ | 20 |
| VPS(Rise) | Rising voltage from power-saving mode | V | 2.2 | _ | _ |
| VPS(fall) | Falling voltage from power-saving mode | V | | _ | 0.5 |
| GF | Gain Flatness, fIF±2.5 MHz | dB | _ | _ | Δ 0.5 |

STANDARD CHARACTERISTICS FOR REFERENCE (unless otherwise specified, TA = 25°C, Vcc = 3.0 V,

fIF = 382.5 MHz, fLO = 760 MHz, PLO = -15 dBm, fI/Q = 2.5 MHz)

| | PART NUMBER PACKAGE OUTLINE | UP8190K QFN-20 | | | |
|---------|---|-------------------|-----|-----|-----|
| SYMBOLS | PARAMETERS AND CONDITIONS | UNITS | MIN | TYP | MAX |
| NF | Noise Figure, Gain = +65 dB | dB | _ | 9.5 | 12 |
| EVM | Error Vector Magnitude, IF = 380 MHz, 3.84 Msps QPSK modulation, Gain is adjusted. | %rms | _ | 3 | _ |
| P1dB | Input Power at 1 dB compression point at Gain = +50 dB | dBm | _ | -45 | _ |

ABSOLUTE MAXIMUM RATINGS¹(TA = 25°C)

| SYMBOLS | PARAMETERS | UNITS | RATINGS |
|------------|----------------------------------|-------|------------------|
| Vcc | Supply Voltage | V | 4.0 |
| VPS, VCONT | Applied Voltage | V | -0.3 to Vcc +0.3 |
| Ta | Operating Ambient Temperature | °C | -40 to +85 |
| Тѕтс | Storage Temperature | °C | -55 to +150 |

Notes

1. Operation in excess of any one of these parameters may result in permanent damage.

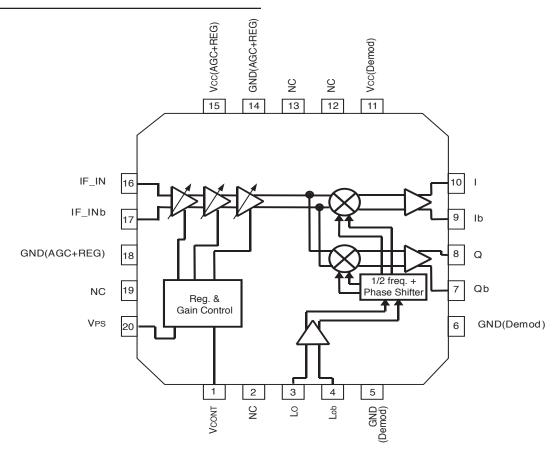
RECOMMENDED OPERATING CONDITIONS

| SYMBOLS | PARAMETERS | UNITS | MIN | TYP | MAX |
|---------|----------------------------------|-------|-----|------|-----|
| Vcc | Supply Voltage | V | 2.7 | 2.85 | 3.3 |
| Та | Operating Ambient Temperature | °C | -25 | +25 | +85 |
| fIF | IF Frequency | MHz | _ | 380 | - |
| fLO | Local Frequency | MHz | - | 760 | _ |
| PLO | Local Input Level | dBm | -18 | -15 | -12 |
| ZI/Q | I/Q Load Impedance | kW | 10 | 20 | - |

ORDERING INFORMATION

| Part Number | Package |
|---------------|--------------------|
| UPC8190K-E1-A | 20 Pin plastic QFN |

BLOCK DIAGRAM (Units in mm)



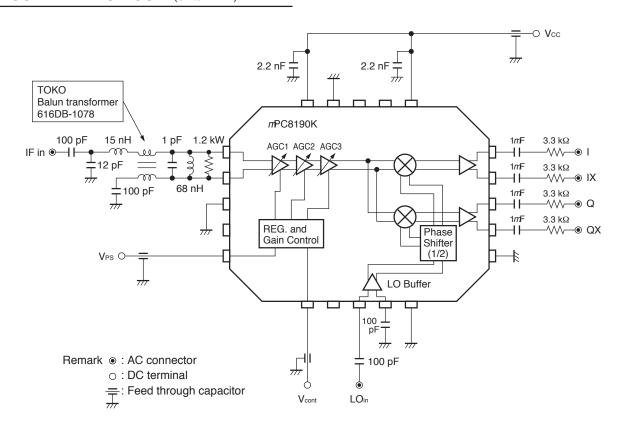
PIN FUNCTIONS (Pin Voltage is measured at Vcc = 3.0 V)

| Pin No. | Pin Name | Applied Voltage (V) | Pin Voltage (V) | Functions and Applications | Internal Equivalent Circuits | | |
|------------|-----------------------|---------------------------|-----------------------|--|------------------------------|--|--|
| 1 | Vcont | 0 to 3.0 | - | Gain control pin of AGC amplifier. Variable gains are available in accordance with applied voltage. | 1 Vcc 54 k 12 k | | |
| 2 19 | N.C. | - | - | Non connection. This pin is not connected to internal circuit. This pin should be opened or grounded. | _ | | |
| 3 | LO | - | - | Local signal input pin of I/Q demodulator. Input frequency is 760 MHz. | Vcc 3 | | |
| 4 | LOb | - | - | Bypass pin of local signal input for I/Q demodulator. In the case of single local input, this pin must be decoupled with capacitor ex. 100 to 1 000 pF. | 4 50 \$ 50 GND | | |
| 5 | GND (Demod.) | 0 | - | Ground pin of I/Q demodulator. This pin should be grounded with minimum inductance. Form the ground pattern as widely as possible to minimize ground impeadance. | | | |
| 7 | Qb | - | - | I/Q/Ib/Qb signal output pins. | Vcc Vcc | | |
| 8 | Q | - | - | Each pin is an emitter follower. | 8.5 k | | |
| 9 | lb | - | - | Each of Ib and Qb is differential output of I and Q. | 78910 | | |
| 10 | I | - | - | Recommendable load impedance is 10 to 20 k Ω . | GND | | |
| 11 | VCC (Demod.) | 2.7 to 3.3 | - | Supply voltage pin of I/Q demodulator (phase shifter + I/Q Mixer). | - | | |
| 12 | TEST 1 | 0 | - | TEST pin. | | | |
| 13 | TEST 2 | 0 | - | In actual use, this pin should be grounded. | _ | | |
| 14 18 | GND (AGC, REG.) | 0 | - | Ground pin of AGC amplifier and internal regulator. This pin should be grounded with minimum inductance. Form the ground pattern as widely as possible to minimize ground impedance. | _ | | |

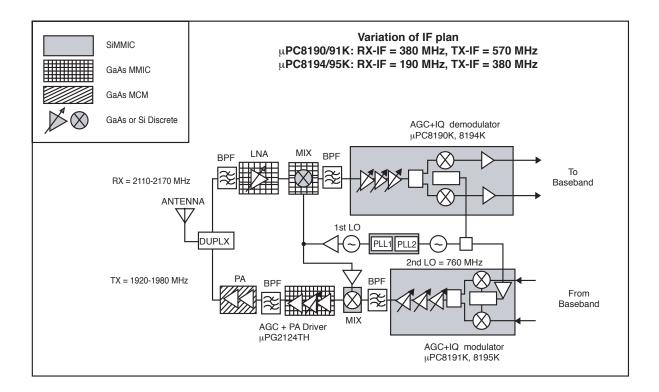
PIN FUNCTIONS (Pin Voltage is measured at Vcc = 3.0 V)

| Pin No. | Pin Name | Applied Voltage (V) | Pin Voltage (V) | Functions | and Applications | Internal Equivaler | nt Circuits |
|------------|-----------------------|---------------------------------|-----------------------|--|---|--------------------|-------------|
| 15 | VCC (AGC, REG.) | 2.7 to 3.3 | - | Supply voltage pin internal regulator. | of AGC amplifier and | _ | |
| 16 | IF_IN | - | - | IF signal input pin. This pin is input of Balance input betw Input frequency is 3 IF signal input pin. In the case of signal must be decoupled | een 16, 17 pin. 380 MHz. al local input, this pin | 16 Vcc 1.2 k 1.2 k | 1.1 k |
| 20 | VPS | H: 2.2 to VCC L: 0 to 0.5 | | Power saving pin. This pin modulator Active/Sleep state VPS (V) 0 to 0.5 2.2 to 3 | can control with bias as follows. State Sleep Mode Active Mode | 100 k 100 k | GND |

MEASUREMENT CIRCUIT (Units in mm)

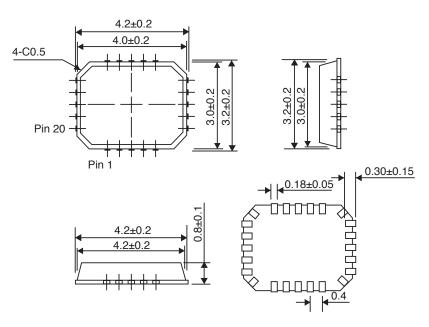


APPLICATION EXAMPLE: W-CDMA



OUTLINE DIMENSIONS (Units in mm)

Package Outline QFN-20



Life Support Applications

These NEC products are not intended for use in life support devices, appliances, or systems where the malfunction of these products can reasonably be expected to result in personal injury. The customers of CEL using or selling these products for use in such applications do so at their own risk and agree to fully indemnify CEL for all damages resulting from such improper use or sale.



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Subject: Compliance with EU Directives

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CEL Pb-free products have the same base part number with a suffix added. The suffix -A indicates that the device is Pb-free. The -AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

| Restricted Substance per RoHS | Concentration Limit per RoHS (values are not yet fixed) | 0000 | on contained devices |
|-------------------------------|---|--------------------|-------------------------|
| Lead (Pb) | < 1000 PPM | -A Not Detected | -AZ (*) |
| Mercury | < 1000 PPM | Not Detected | |
| Cadmium | < 100 PPM | Not Detected | |
| Hexavalent Chromium | < 1000 PPM | Not Detected | |
| PBB | < 1000 PPM | Not Detected | |
| PBDE | < 1000 PPM | Not Detected | |

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

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